xfab

From academic research to the industry

Valerio Pasquali NVM 180nm leader (Staff engineer, XFAB France) GDR Pulse - Porquerolles 08/07/2021 Outline



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Introducing my-self

Scientific background



Università di Roma Tor Vergata

d9/2013 -05/2014 **0**9/2013

Internship on nanodiamod growth by CVD – Bachelor Material Science (S.Orlanducci/M.L. Terranova)

Fabrication by CVD and characterization by SEM and Raman of nano-diamond structures on silicon for application as field-effect emitters.

Università di Roma Tor Vergata

🛲 09/2013 -05/2014

Internship on semiconductor crystal growth by MBE – Master Material Science (E.Placidi/F. Arciprete)

Study of Indium surface diffusion on GaAs structured substrates. During this project I learned the fundamentals of the epitaxial growth of III-V semiconductor by MBE and the characterization by AFM.

Université Sorbonne (previous UPMC)

PhD : "Fabrication and characterization of strain-free GaAs/AlAs quantum dot devices" (P.Atkinson/M.Marangolo) 09/2014 -09/2017

Developing an optical read-out system for single electron quantum processing: The aim of this project was to create a device that can convert a "flying single electron" quantum bit to a single photon, to provide a rapid (GHz) optical read-out for single electron quantum computing. The device consisted of a 2D p-n junction containing embedded self-assembled quantum dots.

UNIVERSITY OF

University of Cambridge and NPL Teddington

CAMBRIDGE 01/2017 -09/2017

Visiting and scientific collaboration (A. Naseer/M. Kataoka)

Modelling, fabrication and characterization of a 2D LED based on 2DEG GaAs/AlGaAs heterostructures grown by MBE where a 2DHG locally

replaced the 2DEG by using a proximity doping technique.

PhD project: QD baded devices





X-FAB Group

Company Confidential



About XFAB

X-FAB at a glance





X-FAB worldwide

xfab



Kuching, Malaysia

Process focus: CMOS, HV-SOI

Capacity: 30,000 wafer starts per month

Wafer size: 8"

Main nodes: 350 nm, 250 nm, 180 nm



Erfurt, Germany

Process focus: CMOS, MEMS, BiCMOS, SOI

Capacity: 21,000 wafer starts per month Wafer size: 6" for CMOS, 6" + 8" for MEMS Main nodes: 1.0 μm, 0.8 μm,

0.6 µm



Dresden, Germany

Process focus: CMOS, GaN-on-Si, MEMS

Capacity: 8,000 wafer starts per month Wafer size: 8"

Main nodes: 0.6 μm, 350 nm



Itzehoe, Germany

Process focus: MEMS Capacity: n/a Wafer size: 8″

Main nodes: n/a



Corbeil, France

Process focus: CMOS, RF-SOI Capacity: 35,000 wafer starts per month Wafer size:

8"

Main nodes: 180 nm, 130 nm



Lubbock, TX, USA

Process focus: SiC, CMOS, BiCMOS, SOI

Capacity: 26,000 wafer starts per month Wafer size:

6"

Main nodes: 1.0 μm, 0.8 μm, 0.6 μm

All quoted capacity numbers exclude MEMS

Technology portfolio

xfab



CMOS & SOI offering

xfab



Large portfolio of CMOS/SOI process technologies

M/S = mixed-signal, NVM = non-volatile memory, RF = radio frequency, SOI = silicon on insulator



What do I do in XFAB



> Coordinate the process transfer from production/R&D to production for the NVM option:

- Define the process flow in strict collaboration with the transfer source and the internal process team
- Design experiments to study the electrical and physical properties of the NVM devices and assess their behaviour by varying
 process parameters
- Analyse electrical and physical parameters
- Choose with the team the most appropriate investigation approach to address electrical/physical failures: e.g. SEM, TEM, AFM, SIMS, μ-probing and so on.
- Follow the reliability tests for the qualification of the automotive products including the NVM option

> Support the Yield Enhancement team on the NVM topics:

- Collaborate with the YE team to identify the root cause behind customer issues: e.g. process defectivity and equipment issues
- Define experiments to address customer issues and yield improvement

> Interface between the R&D NVM team (based in Germany and Malaysia) and the process team in France

- Bring NVM knowledge/expertise from R&D team to process/production team
- Coordinate process improvements for the NVM devices



From the academia to the industry

Some information about my choice



> Why did I decide to leave the university for the industry?

- Willing to see an immediate impact of my work
- Curious to discover new topics: bring products from R&D to mass production and project management
- Geographic and economic stability
- Work in future as an interface between the industry and the academic research

> How did I find the positon in XFAB?

- I started to send CVs around ~6 months before the end of my PhD
- I mainly used two on-line platforms: APEC (French platform) and LinkedIn

> What did help me to get the position ?

- Knowledge on semiconductor devices and experience on charge trapping systems
- Direct experience in clean room fabrication and device characterization
- Experience on a multidisciplinary project
- A class organized by Sorbonne university to help PhD students to get a job in the private sector
- Experience working in international environments

The benefits of a PhD for the industry



- > Strong technical skills and experience on multidisciplinary projects:
 - Developing a deep knowledge in a specific domain
 - Capability to transpose this knowledge to different type of systems: e.g. materials, devices, simulation, theory
 - The student directly works on several topics: theory, simulation, programming, fabrication, characterization
 - The student interacts with a different background (scientist, engineers, technicians, other students)
 - Mentoring students \rightarrow training new colleagues

> Acquisition of a set of transferable skills

- Capability to communicate to different type of audiences
- Create project timelines and adapt them depending on unexpected events
- Developing a critical reasoning
- Capability to navigate the scientific literature
- Manage budget : e.g. to buy software, hardware, lab equipment, to participate to conferences
- Work in a multicultural environment

What opportunities in the industry after a PhD







Thank you.

